

5.0Amp Schottky Barrier Rectifiers

Reverse Voltage 150V Forward Current 5A

SB5150

Features

- Guard ring for over voltage protection.
- Plastic package has UL flammability classification 94V-0
- Low power loss, high efficiency
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Mechanical Data

- Case : JEDEC DO-201AD molded plastic body
- Epoxy : UL94V-0 rate flame retardant
- Terminals: Plated axial leads, solderable per MIL-STD-750 method 2026. High temperature soldering guaranteed: 250°C/10seconds, 0.375”(9.5mm) lead length, 5lbs(2.3kg) tension
- Polarity: Color band denotes cathode end.
- Mounting Position : Any.
- Weight: 0.041 oz., 1.15 gram

Outline



Maximum Ratings and Electrical Characteristics

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%)

Parameter	Symbol	Type	Units
		SB5150	
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum RMS voltage	V_{RMS}	105	V
Maximum DC blocking voltage	V_{DC}	150	V
Maximum instantaneous forward voltage at 5A ¹	V_F	0.92	V
Maximum average forward rectified current @ 0.375”(9.5mm) lead length (see Fig 1)	$I_{F(AV)}$	5	A
Peak forward surge current @8.3ms single half sine wave superimposed on rated load (JEDEC method) at rated T_L	I_{FSM}	125	A
Maximum DC reverse current at rated DC blocking voltage ¹	I_R	$T_A=25^\circ\text{C}$	0.1
		$T_A=100^\circ\text{C}$	5
Typical thermal resistance ²	$R_{\theta JL}$	10	°C/W
Operating junction temperature range	T_J	-55 ~ +175	°C
Storage temperature range	T_{STG}	-55 ~ +175	°C

Note: 1.Pulse test: pulse width \leq 300 μ s, duty cycle \leq 1%

2.Thermal resistance, junction to lead, vertical PCB mounted, 0.375”(9.5mm) lead length

Characteristic Curves

Fig.1- Forward Current

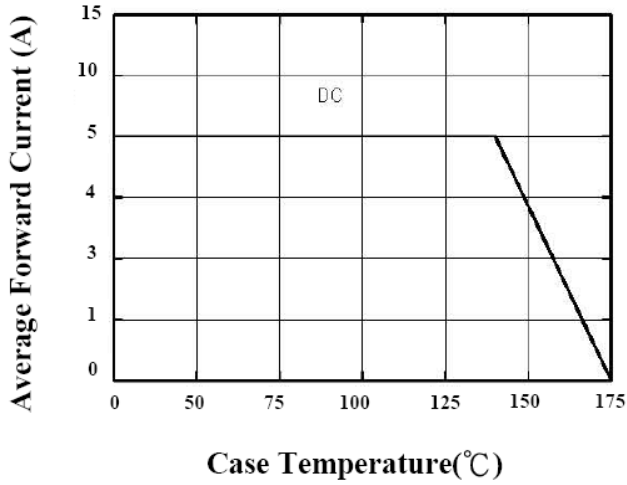


Fig.2- Typical Instantaneous Forward

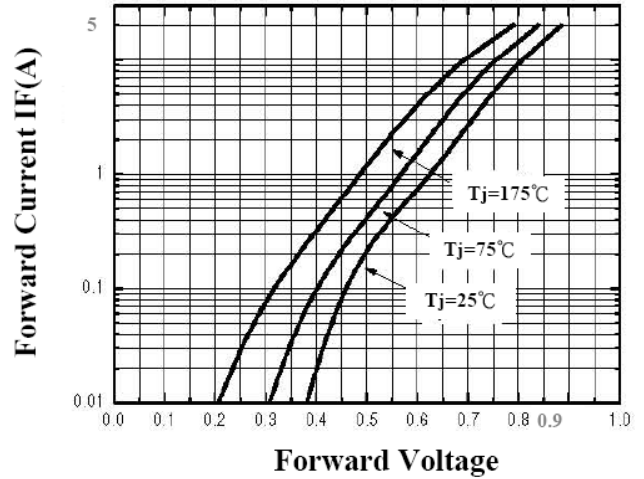


Fig.3- Typical Reverse

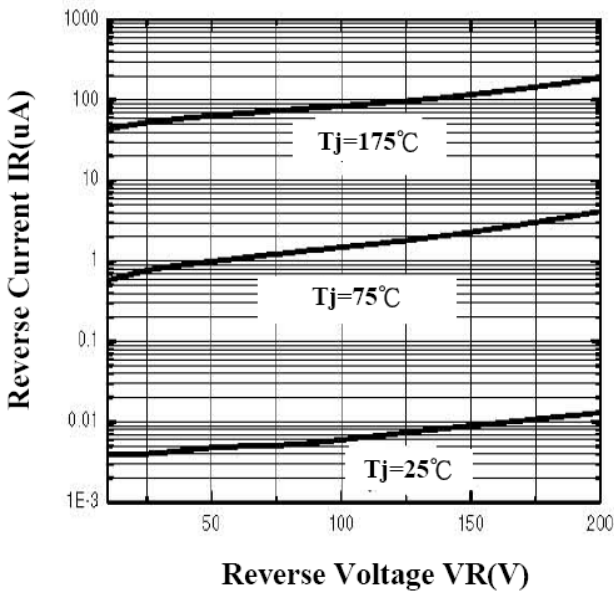
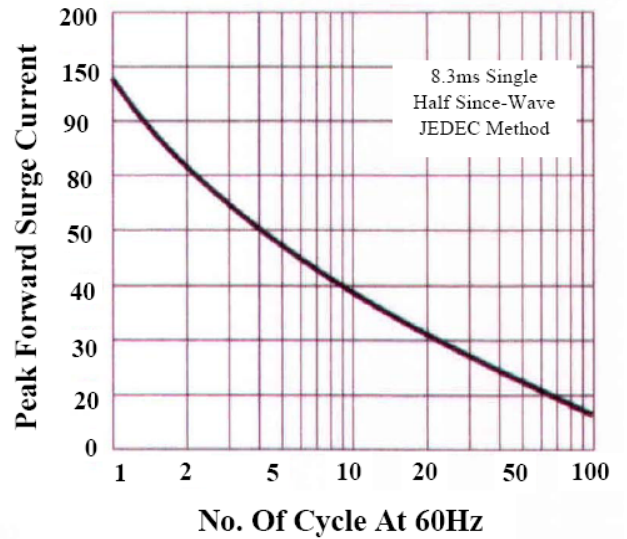
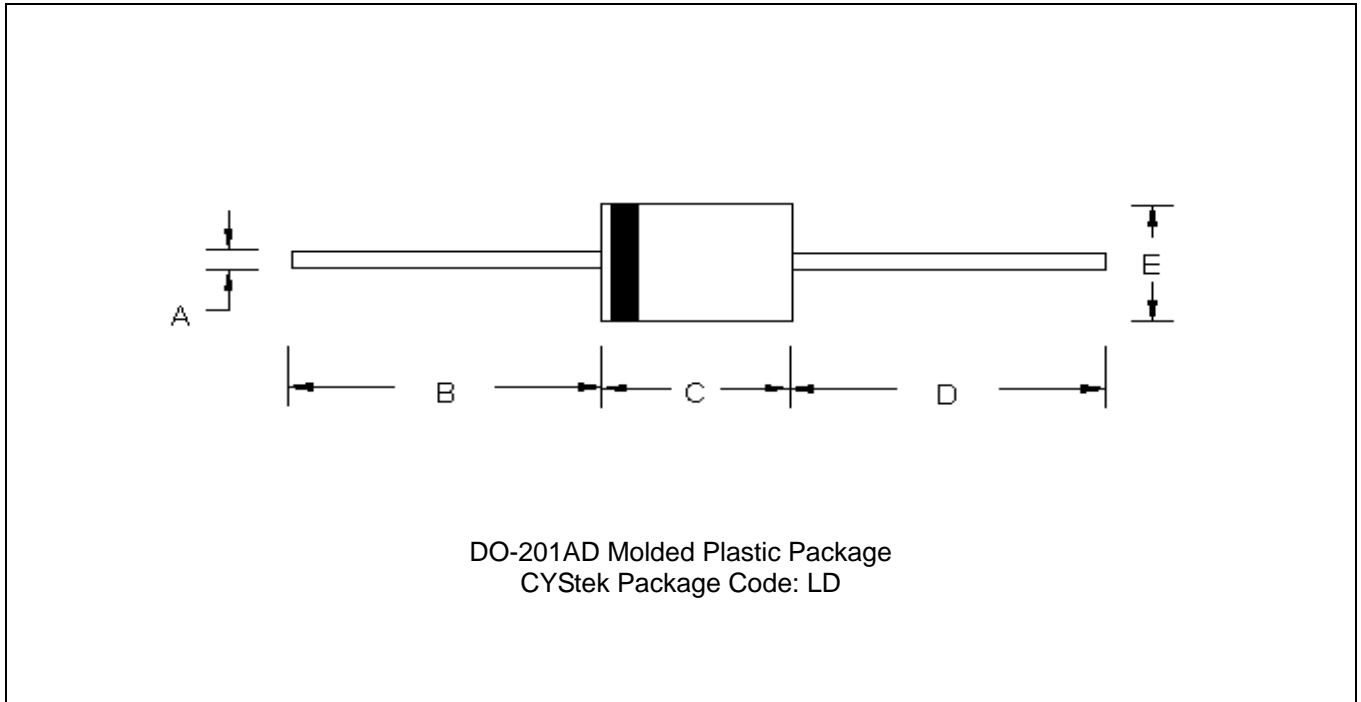


Fig.4- Tmaximum Non -Repetitive Surge Current



DO-201AD Dimension



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	φ0.048	φ0.052	φ1.20	φ1.30	D	1.000	-	25.40	-
B	1.000	-	25.40	-	E	φ0.190	φ0.220	φ4.80	φ5.60
C	0.285	0.375	7.20	9.50					

Notes : 1.Controlling dimension : millimeters.
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material :

- Lead : Axial leads, solderable per MIL-STD-750, Method 2026 guaranteed.
- Mold Compound : Epoxy resin family, flammability solid burning class: UL94V-0

Important Notice:

- All rights are reserved. Reproduction in whole or in part is prohibited without the prior written approval of CYStek.
- CYStek reserves the right to make changes to its products without notice.
- CYStek **semiconductor products are not warranted to be suitable for use in Life-Support Applications, or systems.**
- CYStek assumes no liability for any consequence of customer product design, infringement of patents, or application assistance.